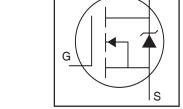


AUTOMOTIVE GRADE

AUIRFS4115-7P

Features

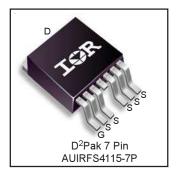
- Advanced Process Technology
- Ultra Low On-Resistance
- Dynamic dv/dt Rating
- 175°C Operating Temperature
- Fast Switching
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified *



D

HEXFET® Power MOSFET

V _{DSS}	150V
R _{DS(on)} typ.	10.0m Ω
max	11.8m Ω
I _D	105A



G	D	S
Gate	Drain	Source

Description

Specifically designed for Automotive applications, this HEXFET® Power MOSFET utilizes the latest processing techniques to achieve extremely low on-resistance per silicon area. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

Symbol	Parameter	Max.	Units
$I_D @ T_C = 25^{\circ}C$	Continuous Drain Current, V _{GS} @ 10V	105	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	74	Α
I _{DM}	Pulsed Drain Current ①	420	
P _D @T _C = 25°C	Maximum Power Dissipation	380	W
	Linear Derating Factor	2.5	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) ②	230	mJ
I _{AR}	Avalanche Current ①	See Fig. 14, 15, 22a, 22b	Α
E _{AR}	Repetitive Avalanche Energy ①		mJ
dv/dt	Peak Diode Recovery ③	32	V/ns
T _J	Operating Junction and	-55 to + 175	°C
T _{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300	
	(1.6mm from case)		
	Mounting torque, 6-32 or M3 screw	10lbf·in (1.1N·m)	

Thermal Resistance

Symbol Parameter		Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ® ®		0.40	°C/W
$R_{\theta JA}$	Junction-to-Ambient (PCB Mount) ⑦		40	

 $\label{eq:hexpectation} \mbox{HEXFET}^{\mbox{\scriptsize @}} \mbox{ is a registered trademark of International Rectifier}.$

^{*}Qualification standards can be found at http://www.irf.com/



Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	150			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.18		V/°C	Reference to 25°C, I _D = 3.5mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		10.	11.8	mΩ	V _{GS} = 10V, I _D = 63A ④
$V_{GS(th)}$	Gate Threshold Voltage	3.0		5.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
gfs	Forward Transconductance	93			S	$V_{DS} = 50V, I_{D} = 62A$
R _{G(int)}	Internal Gate Resistance		2.1		Ω	
I _{DSS}	Drain-to-Source Leakage Current			20	μΑ	$V_{DS} = 150V, V_{GS} = 0V$
				250		$V_{DS} = 150V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 20V
	Gate-to-Source Reverse Leakage			-100		V _{GS} = -20V

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_g	Total Gate Charge		73	110		I _D = 63A
$\overline{Q_gs}$	Gate-to-Source Charge		28		Ī	$V_{DS} = 75V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		28		Ī	V _{GS} = 10V ④
Q _{sync}	Total Gate Charge Sync. (Q _g - Q _{gd})		45		Ī	$I_D = 63A, V_{DS} = 0V, V_{GS} = 10V$
t _{d(on)}	Turn-On Delay Time		18		ns	$V_{DD} = 98V$
t _r	Rise Time		50		Ī	$I_D = 63A$
t _{d(off)}	Turn-Off Delay Time		37			$R_G = 2.1\Omega$
t _f	Fall Time		23			V _{GS} = 10V ④
C _{iss}	Input Capacitance		5320			$V_{GS} = 0V$
C _{oss}	Output Capacitance		490			$V_{DS} = 50V$
C _{rss}	Reverse Transfer Capacitance		110		рF	f = 1.0MHz
C _{oss} eff. (ER)	Effective Output Capacitance (Energy Related)		450		Ī	V _{GS} = 0V, V _{DS} = 0V to 120V ©
C _{oss} eff. (TR)	Effective Output Capacitance (Time Related)		520		İ	V _{GS} = 0V, V _{DS} = 0V to 120V ⑤

Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current			104	Α	MOSFET symbol
	(Body Diode)					showing the
I _{SM}	Pulsed Source Current			420		integral reverse
	(Body Diode) ①					p-n junction diode.
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25$ °C, $I_S = 63$ A, $V_{GS} = 0$ V 4
t _{rr}	Reverse Recovery Time		82		ns	$T_J = 25^{\circ}C$ $V_R = 130V$
			99			$T_J = 125^{\circ}C$ $I_F = 63A$
Q _{rr}	Reverse Recovery Charge		271		nC	$T_J = 25^{\circ}C$ di/dt = 100A/ μ s @
			385			$T_J = 125^{\circ}C$
I _{RRM}	Reverse Recovery Current		6.0		Α	$T_J = 25^{\circ}C$
t _{on}	Forward Turn-On Time	Intrinsio	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)			

Notes:

- ① Repetitive rating; pulse width limited by max. junction
- ② Limited by T_{Jmax} , starting $T_J = 25^{\circ}C$, L = 0.115mH R_G = 25 $\!\Omega,\,I_{AS}$ = 63A, V_{GS} =10V. Part not recommended for use above this value.
- $\label{eq:loss_def} \mbox{ } \mbox{I}_{SD} \leq 63\mbox{A, di/dt} \leq 2510\mbox{A/\mu s, V}_{DD} \leq \mbox{V}_{(BR)DSS}, \mbox{ } \mbox{T}_{J} \leq 175\mbox{°C}.$
- 4 Pulse width $\leq 400 \mu s$; duty cycle $\leq 2\%$.

- ⑤ Coss eff. (TR) is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .
- 6 Coss eff. (ER) is a fixed capacitance that gives the same energy as $C_{oss}\,\text{while}\,\,V_{DS}\,\text{is}$ rising from 0 to 80% $V_{DSS}.$
- ① When mounted on 1" square PCB (FR-4 or G-10 Material). For recom mended footprint and soldering techniques refer to application note #AN-994.
- $\$ R_{θ} is measured at T_J approximately 90°C.



Qualification Information[†]

		Auton	Automotive				
		(per AEC-Q101)					
Qualification Leve	I	Comments: This part nur qualification. IR's Industrial level is granted by extension of	and Consumer qualification				
Moisture Sensitivi	ty Level	D ² Pak 7 Pin MSL1					
Machine Model		Class M3 (+/- 400V) ^{††}					
		AEC-Q101-002					
FOD	Human Body Model	Class H2 (+	-/- 4000V) ^{††}				
ESD		AEC-Q101-001					
	Charged Device Model	Class C5 (+/- 2000V) ^{††}					
		AEC-Q101-005					
RoHS Compliant	-	Yes					

[†] Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

^{††} Highest passing voltage.



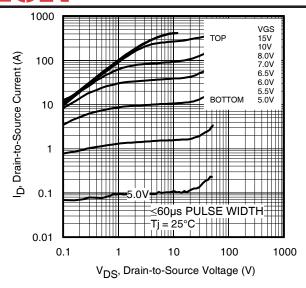


Fig 1. Typical Output Characteristics

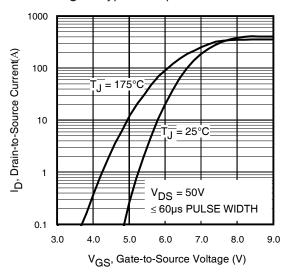


Fig 3. Typical Transfer Characteristics

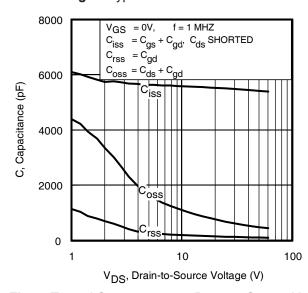


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

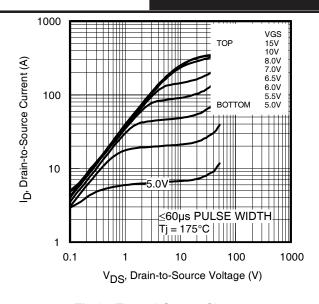


Fig 2. Typical Output Characteristics

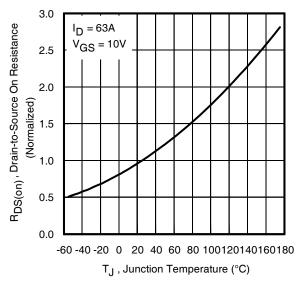


Fig 4. Normalized On-Resistance vs. Temperature

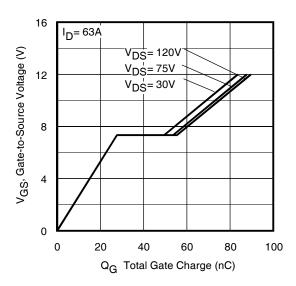


Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage

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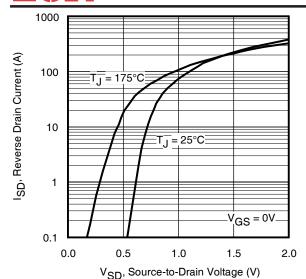


Fig 7. Typical Source-Drain Diode

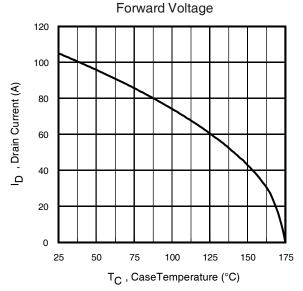


Fig 9. Maximum Drain Current vs. Case Temperature

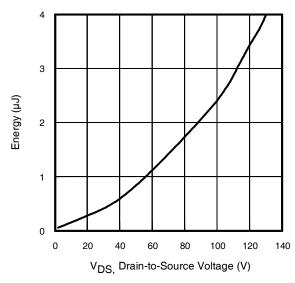


Fig 11. Typical C_{OSS} Stored Energy

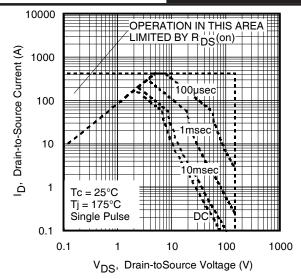


Fig 8. Maximum Safe Operating Area

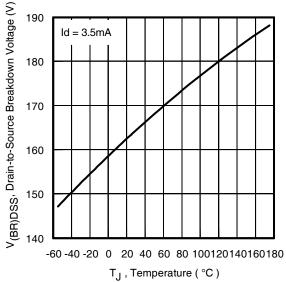


Fig 10. Drain-to-Source Breakdown Voltage

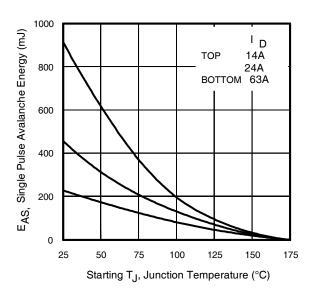


Fig 12. Maximum Avalanche Energy Vs. DrainCurrent

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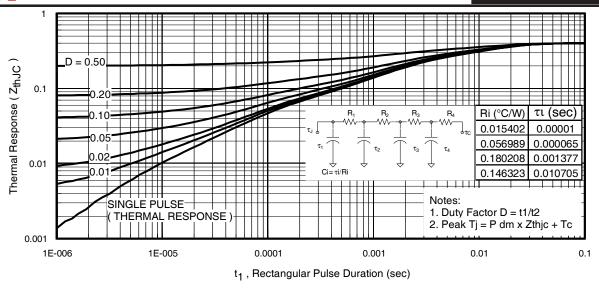


Fig 13. Maximum Effective Transient Thermal Impedance, Junction-to-Case

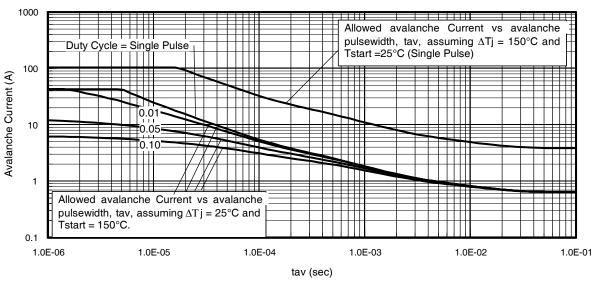


Fig 14. Typical Avalanche Current vs. Pulsewidth

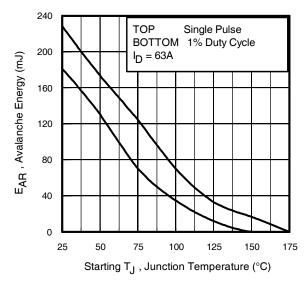


Fig 15. Maximum Avalanche Energy vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 14, 15: (For further info, see AN-1005 at www.irf.com)

- 1. Avalanche failures assumption:
 - Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax} . This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long asT_{imax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 22a, 22b.
- 4. $P_{D (ave)}$ = Average power dissipation per single avalanche pulse.
- BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 14, 15).
- t_{av} = Average time in avalanche.
- D = Duty cycle in avalanche = $t_{av} \cdot f$
- $Z_{th,JC}(D, t_{av})$ = Transient thermal resistance, see Figures 13)

$$\begin{split} P_{D \text{ (ave)}} &= 1/2 \text{ (} 1.3 \cdot \text{BV} \cdot \text{I}_{av} \text{)} = \triangle \text{T/Z}_{thJC} \\ I_{av} &= 2\triangle \text{T/ [} 1.3 \cdot \text{BV} \cdot \text{Z}_{th} \text{]} \\ E_{AS \text{ (AR)}} &= P_{D \text{ (ave)}} \cdot t_{av} \end{split}$$



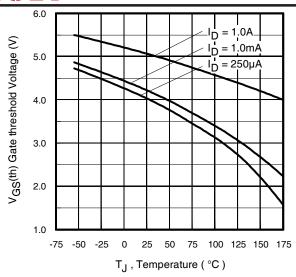


Fig 16. Threshold Voltage Vs. Temperature

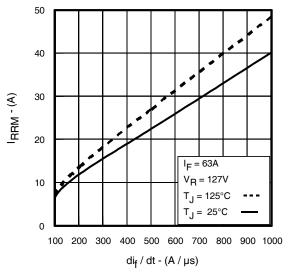


Fig. 18 - Typical Recovery Current vs. dif/dt

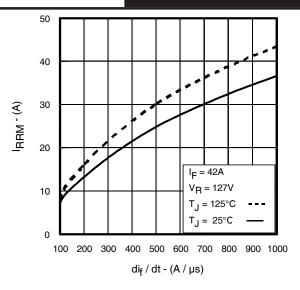


Fig. 17 - Typical Recovery Current vs. di_f/dt

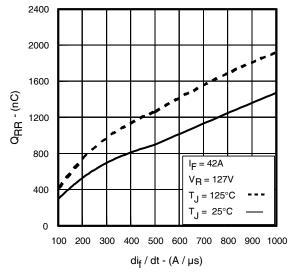


Fig. 19 - Typical Stored Charge vs. di_f/dt

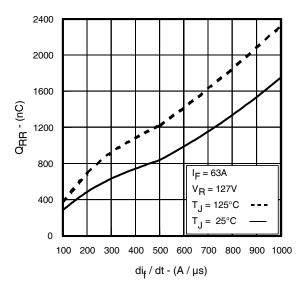


Fig. 20 - Typical Stored Charge vs. dif/dt



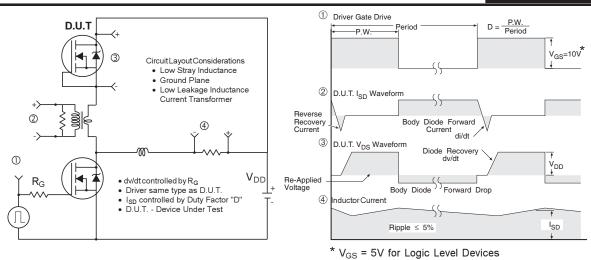


Fig 21. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

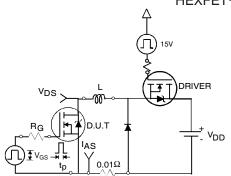


Fig 22a. Unclamped Inductive Test Circuit

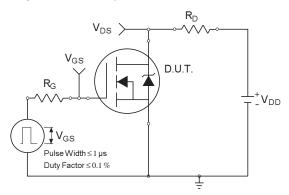


Fig 23a. Switching Time Test Circuit

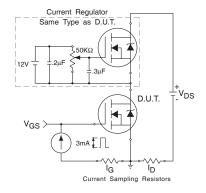


Fig 24a. Gate Charge Test Circuit

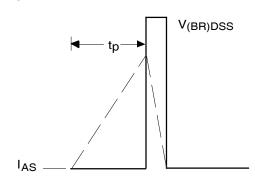


Fig 22b. Unclamped Inductive Waveforms

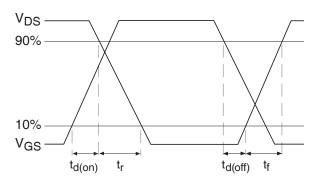


Fig 23b. Switching Time Waveforms

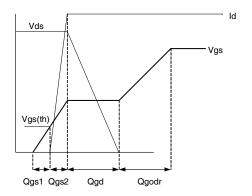
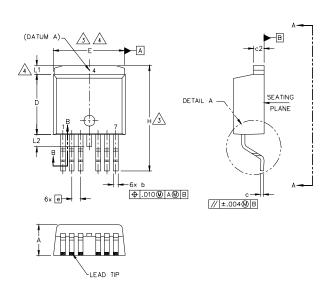


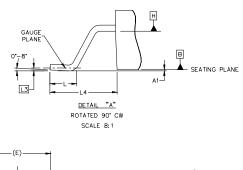
Fig 24b. Gate Charge Waveform

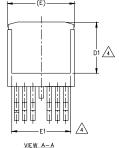


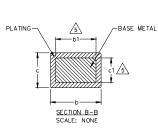
D²Pak - 7 Pin Package Outline

Dimensions are shown in millimeters (inches)









S						
Y M	DIMENSIONS					
S Y M B O L	MILLIM	ETERS	INC	HES	N O T E S	
L	MIN.	MAX.	MIN.	MAX.	S	
Α	4.06	4.83	.160	.190		
A1	_	0.254	_	.010		
ь	0.51	0.99	.020	.036		
b1	0.51	0.89	.020	.032	5	
С	0.38	0.74	.015	.029		
c1	0.38	0.58	.015	.023	5	
c2	1.14	1.65	.045	.065		
D	8.38	9.65	.330	.380	3	
D1	6.86	_	.270		4	
E	9.65	10.67	.380	.420	3,4	
E1	6.22	_	.245		4	
е	1.27	BSC	.050	BSC		
Н	14.61	15.88	.575	.625		
L	1.78	2.79	.070	.110		
L1	_	1.68	-	.066	4	
L2	_	1.78	-	.070		
L3	0.25	BSC	.010	.010 BSC		
L4	4.78	5.28	.188	.208		

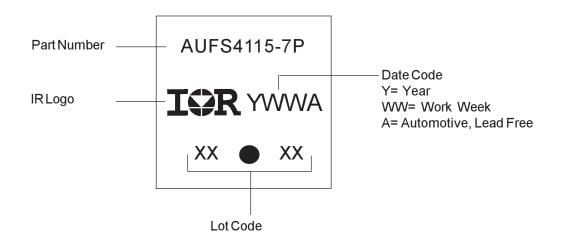
NOTES:

- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M-1994
- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
- 4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
- 5. DIMENSION 61 AND c1 APPLY TO BASE METAL ONLY.
- 6. DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- 7. CONTROLLING DIMENSION: INCH.
- 8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-263CB.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



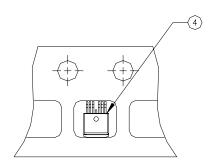
D²Pak - 7 Pin Part Marking Information



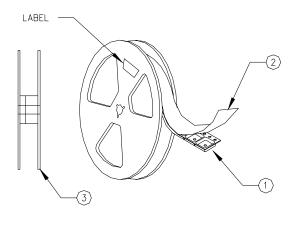
D²Pak - 7 Pin Tape and Reel

NOTES, TAPE & REEL, LABELLING:

- 1. TAPE AND REEL.
 - 1.1 REEL SIZE 13 INCH DIAMETER.
 - 1.2 EACH REEL CONTAINING 800 DEVICES.
 - 1.3 THERE SHALL BE A MINIMUM OF 42 SEALED POCKETS CONTAINED IN THE LEADER AND A MINIMUM OF 15 SEALED POCKETS IN THE TRAILER.
 - 1.4 PEEL STRENGTH MUST CONFORM TO THE SPEC. NO. 71-9667.
 - 1.5 PART ORIENTATION SHALL BE AS SHOWN BELOW.
 - 1.6 REEL MAY CONTAIN A MAXIMUM OF TWO UNIQUE LOT CODE/DATE CODE COMBINATIONS.
 REWORKED REELS MAY CONTAIN A MAXIMUM OF THREE UNIQUE LOT CODE/DATE CODE COMBINATIONS.
 HOWEVER, THE LOT CODES AND DATE CODES WITH THEIR RESPECTIVE QUANTITIES SHALL APPEAR ON THE BAR CODE LABEL FOR THE AFFECTED REEL.



- 2. LABELLING (REEL AND SHIPPING BAG).
 - 2.1 CUST. PART NUMBER (BAR CODE): IRFXXXXSTRL-7P
 - 2.2 CUST. PART NUMBER (TEXT CODE); IRFXXXXSTRL-7P
 - 2.3 I.R. PART NUMBER: IRFXXXXSTRL-7P
 - 2.4 QUANTITY:
 - 2.5 VENDOR CODE: IR
 - 2.6 LOT CODE:
 - 2.7 DATE CODE:



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



Ordering Information

Base part number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRFS4115-7P	D2Pak 7 Pin	Tube	50	AUIRFS4115-7P
		Tape and Reel Left	800	AUIRFS4115-7TRL



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For technical support, please contact IR's Technical Assistance Center http://www.irf.com/technical-info/

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